Darlington Transistor

NPN Silicon

Features

- S Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------|------|
| Collector - Emitter Voltage | V _{CEO} | 40 | Vdc |
| Collector - Base Voltage | V _{CBO} | 40 | Vdc |
| Emitter - Base Voltage | V _{EBO} | 12 | Vdc |
| Collector Current - Continuous | Ic | 500 | mAdc |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|-----------------------------------|-------------|-------------|
| Total Device Dissipation FR–5 Board, (Note 1) T _A = 25°C Derate above 25°C | P _D | 225 1.8 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 556 | °C/W |
| Total Device Dissipation Alumina Substrate, (Note 2) T _A = 25°C Derate above 25°C | P _D | 300 2.4 | mW mW/°C |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 417 | °C/W |
| Junction and Storage Temperature | T _J , T _{stg} | -55 to +150 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. $FR-5 = 1.0 \times 0.75 \times 0.062$ in.
- 2. Alumina = 0.4 x 0.3 x 0.024 in. 99.5% alumina.

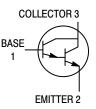


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SOT-23 (TO-236) CASE 318 STYLE 6



MARKING DIAGRAM



1V = Device Code M = Date Code* ■ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping [†] |
|---------------|---------------------|-----------------------|
| MMBT6427LT1G | SOT-23 (Pb-Free) | 3,000 Tape & Reel |
| SMMBT6427LT1G | SOT-23 (Pb-Free) | 3,000 Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|---|-------------------------------------|----------------------------|-------------------------------|------|
| OFF CHARACTERISTICS | | | | |
| Collector – Emitter Breakdown Voltage (I _C = 10 mAdc, V _{BE} = 0) | V _{(BR)CEO} | 40 | - | Vdc |
| Collector – Base Breakdown Voltage ($I_C = 100 \mu Adc, I_E = 0$) | V _{(BR)CBO} | 40 | - | Vdc |
| Emitter – Base Breakdown Voltage ($I_C = 10 \mu Adc$, $I_C = 0$) | V _{(BR)EBO} | 12 | - | Vdc |
| Collector Cutoff Current (V _{CE} = 25 Vdc, I _B = 0) | I _{CES} | - | 1.0 | μAdc |
| Collector Cutoff Current (V _{CB} = 30 Vdc, I _E = 0) | Ісво | - | 50 | nAdc |
| Emitter Cutoff Current (V _{EB} = 10 Vdc, I _C = 0) | I _{EBO} | _ | 50 | nAdc |
| ON CHARACTERISTICS | | | | |
| DC Current Gain | h _{FE} | 10,000 20,000 14,000 | 100,000 200,000 140,000 | - |
| Collector – Emitter Saturation Voltage (I_C = 50 mAdc, I_B = 0.5 mAdc) (I_C = 500 mAdc, I_B = 0.5 mAdc) | V _{CE(sat)} ⁽³⁾ | - - | 1.2 1.5 | Vdc |
| Base – Emitter Saturation Voltage ($I_C = 500$ mAdc, $I_B = 0.5$ mAdc) | V _{BE(sat)} | - | 2.0 | Vdc |
| Base – Emitter On Voltage (I _C = 50 mAdc, V _{CE} = 5.0 Vdc) | V _{BE(on)} | - | 1.75 | Vdc |
| SMALL-SIGNAL CHARACTERISTICS | | | | |
| Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz) | C _{obo} | _ | 7.0 | pF |
| Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz) | C _{ibo} | - | 15 | pF |
| Current Gain – High Frequency (I _C = 10 mAdc, V _{CE} = 5.0 Vdc, f = 100 MHz) | h _{fe} | 1.3 | _ | Vdc |
| Noise Figure (I _C = 1.0 mAdc, V_{CE} = 5.0 Vdc, R_S = 100 k Ω , f = 1.0 kHz) | NF | - | 10 | dB |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. Pulse Test: Pulse Width = $300 \mu s$, Duty Cycle = 2.0%.

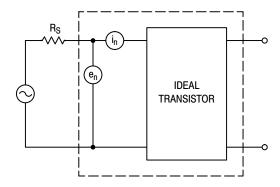


Figure 1. Transistor Noise Model

NOISE CHARACTERISTICS

 $(V_{CE} = 5.0 \text{ Vdc}, T_A = 25^{\circ}C)$

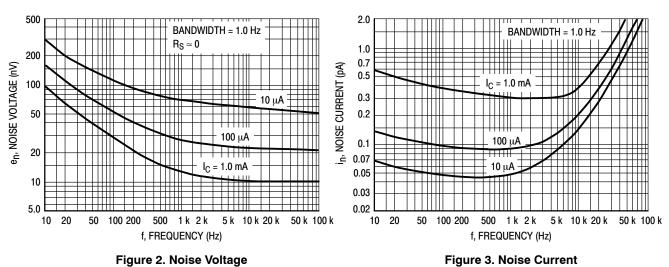


Figure 2. Noise Voltage

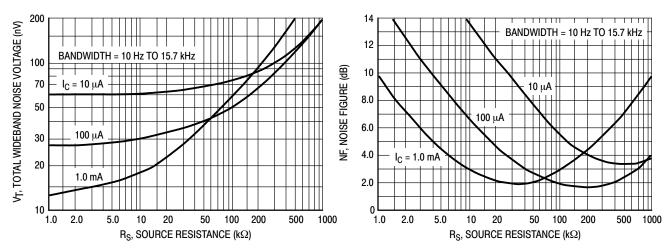
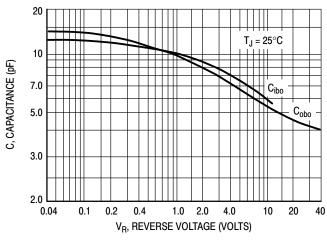


Figure 4. Total Wideband Noise Voltage

Figure 5. Wideband Noise Figure

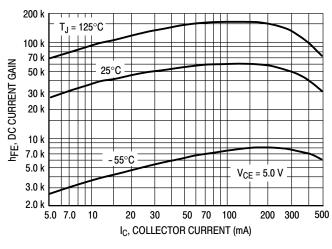
SMALL-SIGNAL CHARACTERISTICS



 $V_{CE} = 5.0 V$ hfel, SMALL-SIGNAL CURRENT GAIN f = 100 MHz $T_J = 25^{\circ}C$ 2.0 1.0 0.8 0.6 0.4 0.2 2.0 20 100 200 500 1.0 0.5 10 50 0.5 IC, COLLECTOR CURRENT (mA)

Figure 6. Capacitance

Figure 7. High Frequency Current Gain



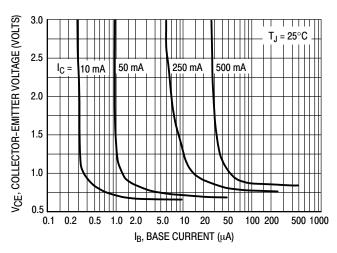
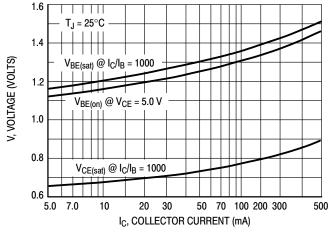


Figure 8. DC Current Gain

Figure 9. Collector Saturation Region



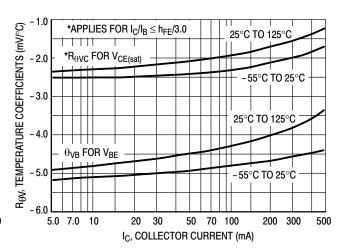


Figure 10. "On" Voltages

Figure 11. Temperature Coefficients

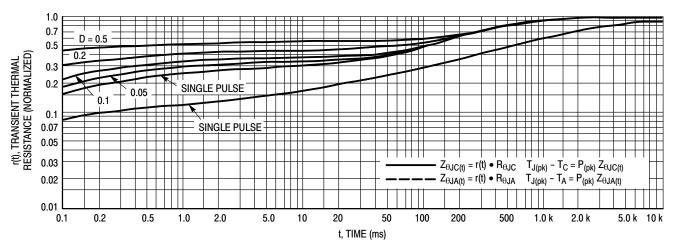
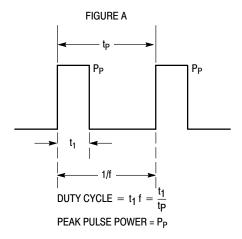


Figure 12. Thermal Response



Design Note: Use of Transient Thermal Resistance Data



SOT-23 (TO-236) CASE 318-08 **ISSUE AS**

DATE 30 JAN 2018

SCALE 4:1 D - 3X b

TOP VIEW







RECOMMENDED SOLDERING FOOTPRINT



DIMENSIONS: MILLIMETERS

NOTES:

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
 MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,

| | PROT | RUSIONS, OR GATE BURRS. | |
|--|------|-------------------------|--|
|--|------|-------------------------|--|

| | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 0.89 | 1.00 | 1.11 | 0.035 | 0.039 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.000 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.017 | 0.020 |
| С | 0.08 | 0.14 | 0.20 | 0.003 | 0.006 | 0.008 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| е | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.080 |
| L | 0.30 | 0.43 | 0.55 | 0.012 | 0.017 | 0.022 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.027 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |
| T | 0° | | 10° | 0° | | 10° |

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

= Date Code

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

| STYLE 1 THRU 5: CANCELLED | STYLE 6: PIN 1. BASE 2. EMITTER 3. COLLECTOR | STYLE 7: PIN 1. EMITTER 2. BASE 3. COLLECTOR | STYLE 8: PIN 1. ANODE 2. NO CONNECTION 3. CATHODE |
|------------------------------|---|---|--|
| OT (1 F O | | | |

SOT-23 (TO-236)

| STYLE 9: | STYLE 10: | STYLE 11: | STYLE 12: | STYLE 13: | STYLE 14: |
|---------------------------|--------------------------|---------------------------------|---------------------------|---------------|-------------------------|
| PIN 1. ANODE | PIN 1. DRAIN | PIN 1. ANODE | PIN 1. CATHODE | PIN 1. SOURCE | PIN 1. CATHODE |
| ANODE | SOURCE | CATHODE | CATHODE | 2. DRAIN | 2. GATE |
| CATHODE | 3. GATE | CATHODE-ANODE | ANODE | 3. GATE | ANODE |

| STYLE 15: | STYLE 16: | STYLE 17: | STYLE 18: | STYLE 19: | STYLE 20: |
|---------------------------|---------------------------|---------------------------|---------------------------|--------------------------------|-------------------------|
| PIN 1. GATE | PIN 1. ANODE | PIN 1. NO CONNECTION | PIN 1. NO CONNECTION | PIN 1. CATHODE | PIN 1. CATHODE |
| CATHODE | CATHODE | 2. ANODE | CATHODE | 2. ANODE | ANODE |
| ANODE | CATHODE | CATHODE | ANODE | CATHODE-ANOD | E 3. GATE |

| STYLE 21: | STYLE 22: | STYLE 23: | STYLE 24: | STYLE 25: | STYLE 26: |
|--------------------------|--------------------------|--------------|-------------|--------------|---------------------------------|
| PIN 1. GATE | PIN 1. RETURN | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE |
| SOURCE | OUTPUT | 2. ANODE | 2. DRAIN | 2. CATHODE | 2. ANODE |
| 3 DRAIN | 3 INPLIT | 3 CATHODE | 3. SOURCE | 3. GATE | NO CONNECTION |

| STYLE 27: PIN 1. CATHODE 2. CATHODE 3. CATHODE | STYLE 28: PIN 1. ANODE 2. ANODE 3. ANODE | |
|---|---|--|
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